

FDC6302P Digital FET, Dual P-Channel

General Description

These Dual P-Channel logic level enhancement mode field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance. This device has been designed especially for low voltage applications as a replacement for digital transistors in load switchimg applications. Since bias resistors are not required this one P-Channel FET can replace several digital transistors with different bias resistors like the IMBxA series.

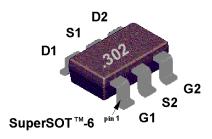
Features

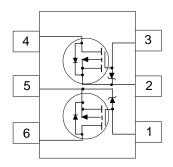
■ -25 V, -0.12 A continuous, -0.5 A Peak.

$$\begin{aligned} R_{\rm DS(ON)} &= 13~\Omega~@~V_{\rm GS} = -2.7~V \\ R_{\rm DS(ON)} &= 10~\Omega~@~V_{\rm GS} = -4.5~V. \end{aligned}$$

- Very low level gate drive requirements allowing direct operation in 3V circuits. V_{GS(th)} < 1.5V.
- Gate-Source Zener for ESD ruggedness. >6kV Human Body Model
- Replace multiple PNP digital transistors (IMHxA series) with one DMOS FET.







Absolute Maximum Ratings $T_A = 25^{\circ}C$ unless other wise noted

Symbol	Parameter		FDC6302P	Units
V _{DSS}	Drain-Source Voltage		-25	
V_{GSS}	Gate-Source Voltage		-8	V
I _D	Drain Current - Continuous		-0.12	А
	- Pulsed		-0.5	
P_{D}	Maximum Power Dissipation	(Note 1a)	0.9	W
		(Note 1b)	0.7	
T_{J},T_{STG}	Operating and Storage Temperature Range		-55 to 150	°C
ESD	Electrostatic Discharge Rating MIL-STD-883D Human Body Model (100pf / 1500 Ohm)		6.0	kV
THERMA	L CHARACTERISTICS	•		<u>.</u>
R _{eja}	Thermal Resistance, Junction-to-Ambient	(Note 1a)	140	°C/W
R _{euc}	Thermal Resistance, Junction-to-Case	(Note 1)	60	°C/W

Symbol	Parameter	Conditions		Min	Тур	Max	Units
OFF CHAR	ACTERISTICS						
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_{D} = -250 \mu\text{A}$		-25			V
$\Delta BV_{DSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient	I _D = -250 μA, Referenced to 25 °C			-20		mV /°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -20 \text{ V}, \ V_{GS} = 0 \text{ V}$				-1	μΑ
		T _J =	55°C			-10	μA
I _{GSS}	Gate - Body Leakage Current	$V_{GS} = -8 \text{ V}, \ V_{DS} = 0 \text{ V}$				-100	nA
ON CHARA	CTERISTICS (Note 2)						
$\Delta V_{GS(th)}/\Delta T_{J}$	Gate Threshold Voltage Temp. Coefficient	$I_D = -250 \mu\text{A}$, Referenced to 25 °C	С		1.9		mV /°C
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \mu\text{A}$		-0.65	-1	-1.5	V
R _{DS(ON)}	Static Drain-Source On-Resistance	$V_{GS} = -2.7 \text{ V}, I_{D} = -0.05 \text{A}$			10.6	13	Ω
		$V_{GS} = -4.5 \text{ V}, I_{D} = -0.2 \text{ A}$			7.9	10	
		T _J =	125°C		12	18	
I _{D(ON)}	On-State Drain Current	$V_{GS} = -2.7 \text{ V}, \ V_{DS} = -5 \text{ V}$		-0.05			Α
g _{FS}	Forward Transconductance	$V_{DS} = -5 \text{ V}, I_{D} = -0.2 \text{ A}$			0.135		S
DYNAMIC (CHARACTERISTICS	•					•
C _{iss}	Input Capacitance	$V_{DS} = -10 \text{ V}, \ V_{GS} = 0 \text{ V},$ $f = 1.0 \text{ MHz}$			11		pF
C _{oss}	Output Capacitance				7		pF
C _{rss}	Reverse Transfer Capacitance				1.4		pF
SWITCHING	CHARACTERISTICS (Note 2)						
t _{D(on)}	Turn - On Delay Time	$V_{DD} = -6 \text{ V}, \ I_{D} = -0.2 \text{ A},$ $V_{GS} = -4.5 \text{ V}, \ R_{GEN} = 50 \Omega$			5	12	ns
t _r	Turn - On Rise Time				8	16	ns
$\mathbf{t}_{D(off)}$	Turn - Off Delay Time				9	18	ns
t _f	Turn - Off Fall Time				5	10	ns
Q_g	Total Gate Charge	$V_{DS} = -5 \text{ V}, I_{D} = -0.2 \text{ A},$ $V_{GS} = -4.5 \text{ V}$			0.22	0.31	nC
Q_{gs}	Gate-Source Charge				0.12		nC
Q_{gd}	Gate-Drain Charge				0.05		nC
DRAIN-SOL	IRCE DIODE CHARACTERISTICS AND MAXI	MUM RATINGS				1	
l _s	Maximum Continuous Drain-Source Diode Forward Current					-0.7	Α
V_{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_{S} = -0.7 \text{ A} \text{ (Note 2)}$			-1	-1.3	V

Notes:
1. R_{a.s.} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{g.c.} is guaranteed by design while R_{g.c.} is determined by the user's board design.



a. 140°C/W on a 0.125 in² pad of 2oz copper.



b. 180°C/W on a 0.005 in² of pad of 2oz copper.

2. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%.

Typical Electrical Characteristics

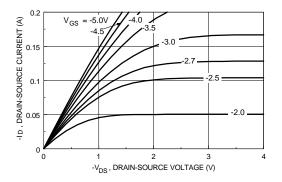


Figure 1. On-Region Characteristics.

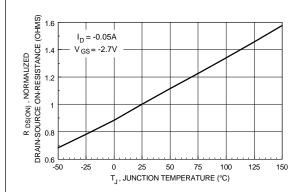


Figure 3. On-Resistance Variation with Temperature.

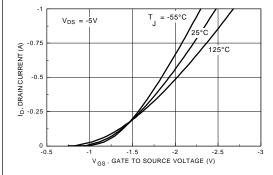


Figure 5. Transfer Characteristics.

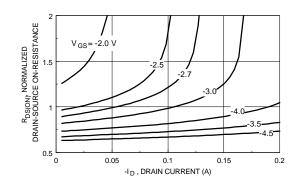


Figure 2. On-Resistance Variation with Drain Current and Gate Voltage.

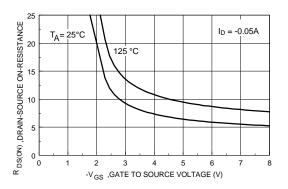


Figure 4. On Resistance Variation with Gate-To- Source Voltage.

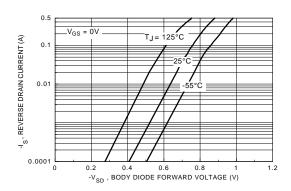


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature.

Typical Electrical And Thermal Characteristics

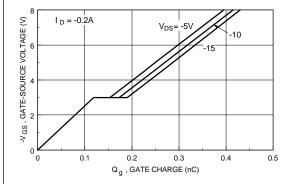


Figure 7. Gate Charge Characteristics.

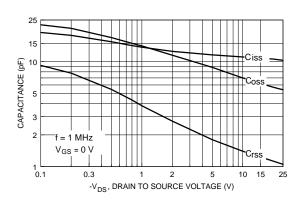


Figure 8. Capacitance Characteristics.

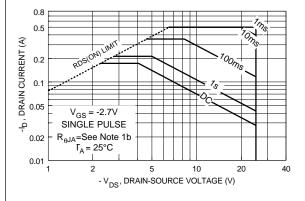


Figure 9. Maximum Safe Operating Area.

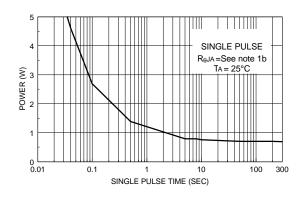


Figure 10. Single Pulse Maximum Power Dissipation.

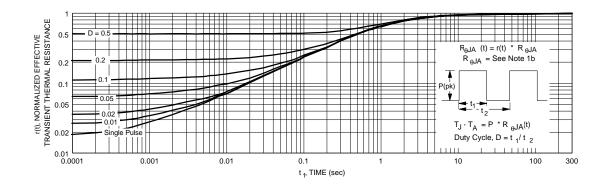


Figure 11. Transient Thermal Response Curve.

Note: Thermal characterization performed using the conditions described in note 1b.Transient thermal response will change depending on the circuit board design.

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